

GAN3R2-100CBE

100 V, 3.2 mOhm Gallium Nitride (GaN) FET in a
3.5 mm x 2.13 mm Wafer Level Chip-Scale Package (WLCSP)

27 April 2023

Product data sheet

1. General description

The GAN3R2-100CBE is a a general purpose 100 V, 3.2 m Ω Gallium Nitride (GaN) FET in a 15 bump Wafer Level Chip-Scale Package (WLCSP). It is a normally-off e-mode device offering superior performance.

2. Features and benefits

- · Enhancement mode normally-off power switch
- · Ultra high frequency switching capability
- · No body diode
- · Low gate charge, low output charge
- Qualified for standard applications
- ESD protection
- RoHS, Pb-free, REACH-compliant
- High efficiency and high power density
- Wafer Level Chip-Scale Package (WLCSP) 3.5 mm x 2.13 mm

3. Applications

- · High power density and high efficiency power conversion
- AC-to-DC converters, (secondary stage)
- · High frequency DC-to-DC converters in 48 V systems
- Fast battery charging, mobile phone, laptop, tablet and USB type-C chargers
- Datacom and telecom (AC-to-DC and DC-to-DC) converters
- Motor drives
- LiDAR (non-automotive)
- · Class D audio amplifiers

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage			-	-	100	V
V _{TDS}	transient drain to source voltage	pulsed; $t_p = 1 \mu s$; $\delta_{factor} = 0.01$		-	-	130	V
I _D	drain current	V _{GS} = 5 V	[1]	-	-	60	А
P _{tot}	total power dissipation	Fig. 1		-	-	394	W
Tj	junction temperature			-40	-	150	°C
Static characte	eristics						
R _{DSon}	drain-source on-state resistance	V _{GS} = 5 V; I _D = 25 A; T _j = 25 °C; <u>Fig. 9</u> ; <u>Fig. 10</u> ; <u>Fig. 11</u> ; <u>Fig. 12</u>		-	2.4	3.2	mΩ
R_{G}	gate resistance	f = 5 MHz; T _j = 25 °C		-	2.2	-	Ω



100 V, 3.2 mOhm Gallium Nitride (GaN) FET in a 3.5 mm x 2.13 mm Wafer Level Chip-Scale Package

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Dynamic characteristics							
Q_{GD}	gate-drain charge	I _D = 25 A; V _{DS} = 50 V; V _{GS} = 5 V;		-	1.7	-	nC
Q _{G(tot)}	total gate charge	T _j = 25 °C; <u>Fig. 13; Fig. 14</u>		-	9.2	12	nC
Q _{oss}	output charge	V _{GS} = 0 V; V _{DS} = 50 V; T _j = 25 °C	[2]	-	50	-	nC

^[1] Limited by package

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	S	source	3	
3	D	drain		
4	S	source	4	D
5	D	drain	5	
6	S	source	6	G — (i
7	D	drain	7	
8	S	source	8	_{aaa-036394} S
			Transparent top view	
			WLCSP8 (WLCSP8- SOT8072)	

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
GAN3R2-100CBE	WLCSP8	wafer level chip-scale package; 8 solder bars; body: 3.5 x 2.13 x 0.429 mm	WLCSP8-SOT8072		

7. Marking

Table 4. Marking codes

Type number	Marking code
GAN3R2-100CBE	3R2DCBE

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Tj = 25 °C unless otherwise stated.

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	100	V

^[2] Q_r is not specified separately from Q_{oss} for e-mode GaN FETs, since Q_r = Q_{oss} + Q_D, and Q_D = 0. (Q_D is charge associated with diffusion of minority carriers. Since there is no body diode, no minority carriers in excess of Q_{oss} have to be transferred for e-mode GaN FETs.)

100 V, 3.2 mOhm Gallium Nitride (GaN) FET in a 3.5 mm x 2.13 mm Wafer Level Chip-Scale Package

Symbol	Parameter	Conditions		Min	Max	Unit
Cymbol	1 drameter				IVIGA	Oint
V_{TDS}	transient drain to source voltage	pulsed; $t_p = 1 \mu s$; $\delta_{factor} = 0.01$		-	130	V
V_{GS}	gate-source voltage			-4	6	V
P _{tot}	total power dissipation	Fig. 1		-	394	W
I _D	drain current	V _{GS} = 5 V	[1]	-	60	А
I _{DM}	peak drain current	pulsed; t _p ≤ 10 µs; <u>Fig. 2</u>	[1]	-	230	А
T _{stg}	storage temperature			-40	150	°C
T _j	junction temperature			-40	150	°C
$T_{sld(M)}$	peak soldering temperature			-	260	°C

[1] Limited by package

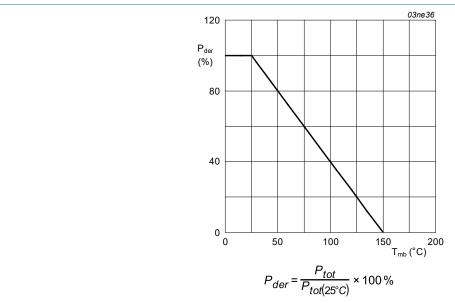
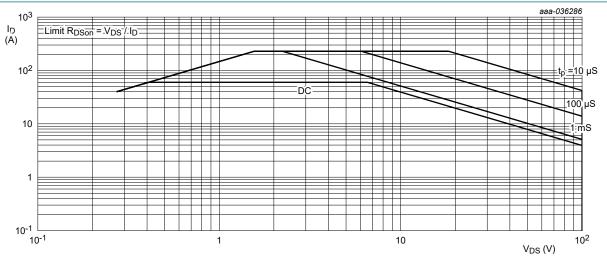


Fig. 1. Normalized total power dissipation as a function of mounting base temperature



 T_{mb} = 25 °C; I_{DM} is a single pulse

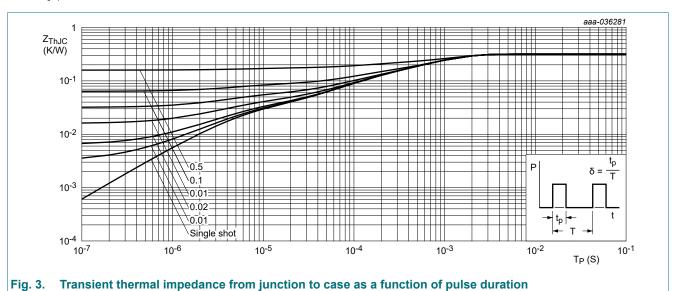
Fig. 2. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-c)}	thermal resistance from junction to case	Fig. 3		-	-	0.3	K/W
R _{th(j-mb)}	thermal resistance from junction to mounting base			-	-	1.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient		[1]	-	-	33	K/W

[1] R_{th(j-a)} is determined with the device mounted on one square inch of copper pad, single layer 2 oz copper on FR4 board.



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V _{(BR)DSS}	drain-source breakdown voltage	I _D = 400 μA; V _{GS} = 0 V; T _j = 25 °C	100	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 9 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}; Fig. 8$	0.8	1.1	2.5	V
I _{DSS}	drain leakage current	V _{DS} = 80 V; V _{GS} = 0 V; T _j = 25 °C	-	80	350	μA
I _{GSS}	gate leakage current	V _{GS} = 5 V; V _{DS} = 0 V; T _j = 25 °C	-	20	5000	μΑ
		V _{GS} = 5 V; V _{DS} = 0 V; T _j = 125 °C	-	600	9000	μA
		V _{GS} = -4 V; V _{DS} = 0 V; T _j = 25 °C	-	60	400	μA
R _{DSon}	drain-source on-state resistance	V _{GS} = 5 V; I _D = 25 A; T _j = 25 °C; <u>Fig. 9</u> ; <u>Fig. 10</u> ; <u>Fig. 11</u> ; <u>Fig. 12</u>	-	2.4	3.2	mΩ
R _G	gate resistance	f = 5 MHz; T _j = 25 °C	-	2.2	-	Ω

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
-	naracteristics				- 71		
Q _{G(tot)}	total gate charge	I _D = 25 A; V _{DS} = 50 V; V _{GS} = 5 V;		-	9.2	12	nC
Q _{GS}	gate-source charge	T _j = 25 °C; <u>Fig. 13</u> ; <u>Fig. 14</u>		-	1.9	-	nC
Q _{GD}	gate-drain charge			-	1.7	-	nC
C _{iss}	input capacitance	$V_{DS} = 50 \text{ V}; V_{GS} = 0 \text{ V}; f = 100 \text{ kHz};$		-	1000	-	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 15</u>		-	460	-	pF
C _{rss}	reverse transfer capacitance			-	8.2	-	pF
C _{o(er)}	effective output capacitance, energy related	$0 \text{ V} \le \text{ V}_{DS} \le 50 \text{ V}; \text{ V}_{GS} = 0 \text{ V};$ $\text{T}_{j} = 25 \text{ °C}; \frac{\text{Fig. } 16}{}$	[1]	-	700	-	pF
C _{o(tr)}	effective output capacitance, time related	$0 \text{ V} \le \text{ V}_{DS} \le 50 \text{ V}; \text{ V}_{GS} = 0 \text{ V};$ $\text{T}_{j} = 25 \text{ °C}$	[2]	-	1020	-	pF
Q _{oss}	output charge	V _{GS} = 0 V; V _{DS} = 50 V; T _j = 25 °C	[3]	-	50	-	nC
Source-dra	in characteristics		'	'	'	_	
V_{SD}	source-drain voltage	I _S = 0.5 A; V _{GS} = 0 V; T _j = 25 °C; Fig. 17; Fig. 18; Fig. 19; Fig. 20		-	1.5	-	V

- $C_{O(er)}$ is the fixed capacitance that gives the same stored energy as C_{OSS} while V_{DS} is rising from 0 to 50 V
- [2]
- $C_{O(er)}$ is the fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising from 0 to 50 V Q_r is not specified separately from Q_{oss} for e-mode GaN FETs, since $Q_r = Q_{oss} + Q_D$, and $Q_D = 0$. (Q_D is charge associated with diffusion of minority carriers. Since there is no body diode, no minority carriers in excess of Q_{oss} have to be transferred for e-mode GaN FETs.)

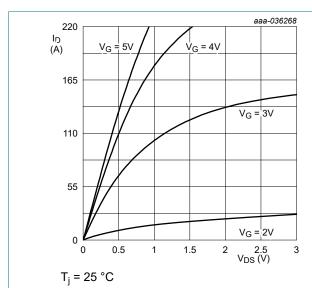


Fig. 4. Output characteristics: drain current as a function of drain-source voltage; typical values

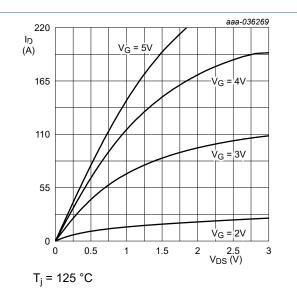


Fig. 5. Output characteristics: drain current as a function of drain-source voltage; typical values

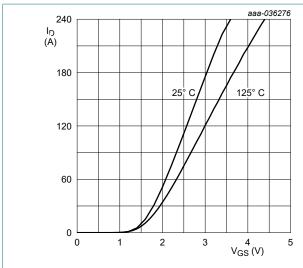


Fig. 6. Transfer characteristics; drain current as a function of gate-source voltage; typical values



Freq. = 100 kHz

Fig. 7. Output charge as a function of drain-source voltage; typical values

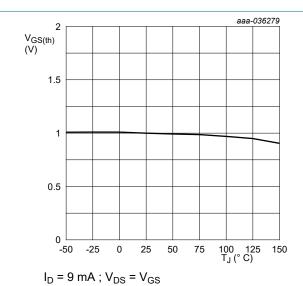


Fig. 8. Gate-source threshold voltage as a function of junction temperature

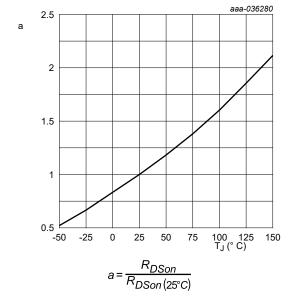


Fig. 9. Normalized drain-source on-state resistance factor as a function of junction temperature

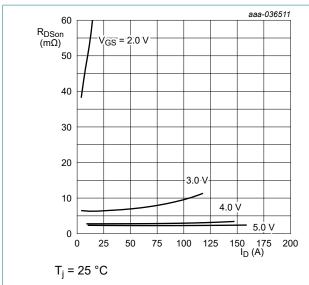


Fig. 10. Drain-source on-state resistance as a function of drain current; typical values

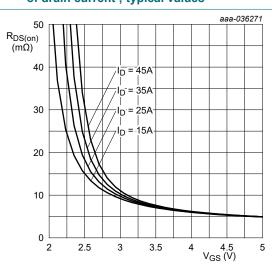


Fig. 12. Drain-source on-state resistance as a function of gate-source voltage; typical values

T_i = 125 °C

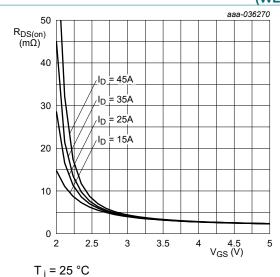


Fig. 11. Drain-source on-state resistance as a function of gate-source voltage; typical values

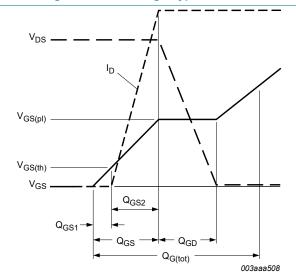
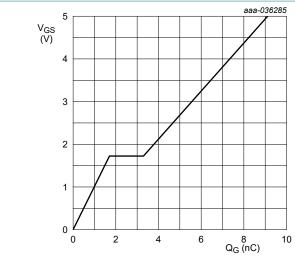


Fig. 13. Gate charge waveform definitions



 $T_{.1} = 25 \,^{\circ} \,^{\circ} C \,^{\circ} \,^{\circ} I_{D} = 25 \,^{\circ} A$

Fig. 14. Gate-source voltage as a function of gate charge; typical values

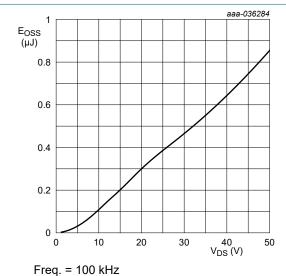


Fig. 16. COSS stored energy as a function of drainsource voltage; typical values

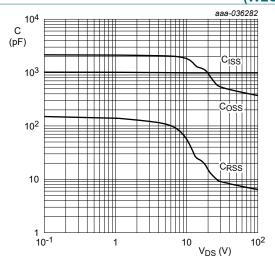


Fig. 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

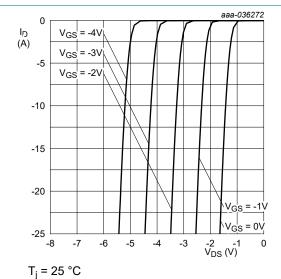


Fig. 17. Source current as a function of source-drain voltage; typical values

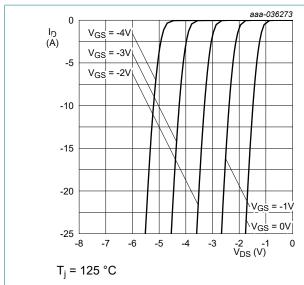


Fig. 18. Source current as a function of source-drain voltage; typical values

T_i = 125 °C

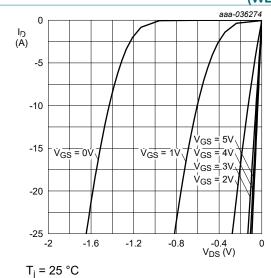


Fig. 19. Source current as a function of source-drain voltage; typical values

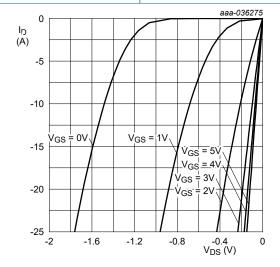


Fig. 20. Source current as a function of source-drain voltage; typical values

11. Package outline

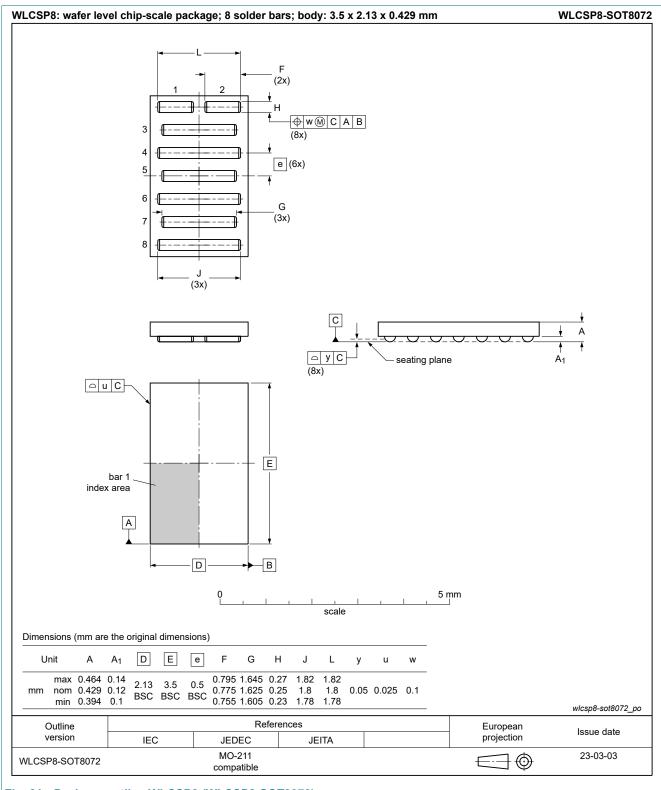
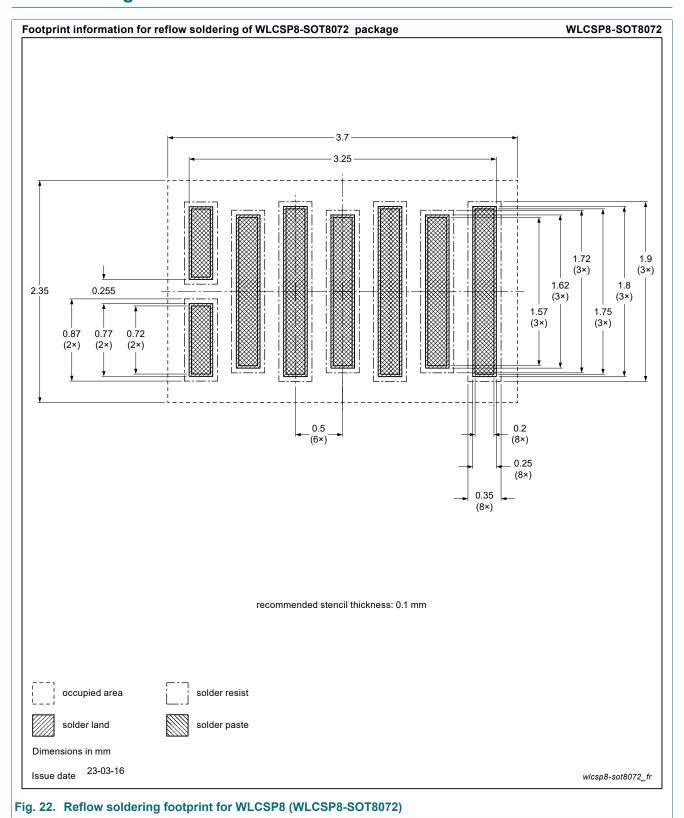


Fig. 21. Package outline WLCSP8 (WLCSP8-SOT8072)

12. Soldering



13. Legal information

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